

Declaration of Identity

Hereby,

Name of Applicant

Hisense International Co., Ltd.

Address:

Floor 22, Hisense Tower, 17 Donghai Xi Road, Qingdao, 266071, China

City:

Qingdao,

Country:

China

declares that this equipment:

Product description:

Mobile Phone

Type designation(s):

HL237E

Trademark:

Hisense

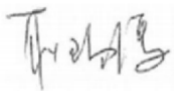
is different on the supplier of Memory

Main Supply

Part Name	Model	Supplier(Brand)	Description
Memory (RAM)	FLXC4003G-50)	FORESEE	LPDDR4X 3GB 200-Ball VFBGA 14.5*10*1.0mm Wafer-Micron
Memory (ROM)	FEMDNN064G-58A44	FORESEE	EMMC 64GB 153FBGA 11.5*13*1.0mm, Wafer-Samsung V5

Secondary Supply

Part Name	Model	Supplier(Brand)	Description
Memory (RAM)	RS768M32LB4D2 BDS-53BT)	Rayson	LPDDR4X 3GB 200-Ball VFBGA 14.5*10*1.0mm Wafer-Micron
Memory (ROM)	FEMDNN064G-A3A56	FORESEE	EMMC 64GB 153FBGA 11.5*13*1.0mm, Wafer-Samsung V6



March 16, 2022

Hisense International Co., Ltd.

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